

# APPROVAL SHEET

**Item:** S3215C Crystal

**Spec. no:** S3215C-032768-12-20-CA

**Freq:** 32.768 KHz

<b>Customer Approved</b>	Checked By	Issued By		
	成慧美	華秋賀		

## 友桂電子股份有限公司 YOKETAN CORPORATION

E-mail: yoketec@ms14.hinet.net http://www.yoketant.com.tw

台灣台中工廠: (42760) 台中市潭子區台中加工出口區南二路28號-2

Tel: 886-4-25333353 Fax: 886-4-25338675

台灣台北公司: (24250) 新北市新莊區中山路一段107號9樓之3

Tel: 886-2-85227548 Fax: 886-2-85227546

廣東肇慶工廠: (526020) 廣東省肇慶市站港北路大洲工業區C棟三樓

Tel: 86-758-6152666 Fax: 86-758-6152699

中國深圳公司: (518008) 深圳市羅湖區紅崗北路紅崗大廈2106

Tel: 86-755-25936978 Fax: 86-755-25907970

中國無錫公司: (214101) 無錫市東亭鎮華夏中路10號商檢局新大樓1009 Tel: 86-510-88708842 Fax: 86-510-88211895















## **REVISION HISTORY**

Rev	Revise page	Revise Contents	<u>Date</u>	Ref.No.	Reviser
A	N/A	INITIAL ISSUE	2012/7/19	N/A	Aki Hsieh
A	Page.3	Add marking	2013/7/2	N/A	Aki Hsieh

## **SPECIFICATION OF CRYSTAL UNITS**

YOKETAN CORP.

Customer: 捷盛 SPEC NO: S3215C-032768-12-20-CA

(Lead Free Parts)

**Date: 19-Jul-12** 

#### SPECIFICATION OF CRYSTAL UNITS

1 Nominal frequency 32.768 KHz

2 Frequency tolerance  $\pm 20$ ppm at  $25 \pm 2$  °C

3 Temperature characteristics

-Turnover temperature  $25 \pm 5$  °C

-Temperature Coefficient  $-0.045 \times 10^{-6}$  /°C Max.

4 Operating temperature -40 to +85 degrees

5 Equiverent series resistance 70k ohms Max.

6 Load capacitance 12.5pF

7 Shunt capacitance 2.0pF Max.

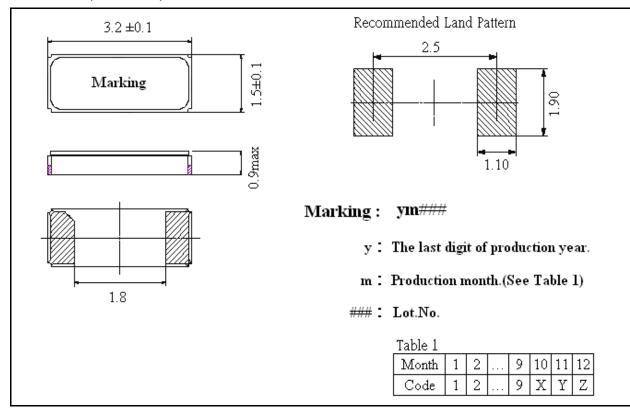
8 Drive level 1.0uW Max.

9 Storage temperature -55 to +125 degrees

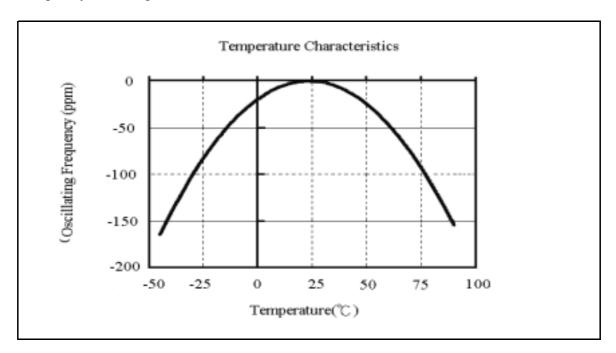
10 Aging(First year)  $\pm$  3ppm Max.

11 Unit Net of Weight  $0.012g \pm 0.0006g$ 

12 Dimension (unit: mm)

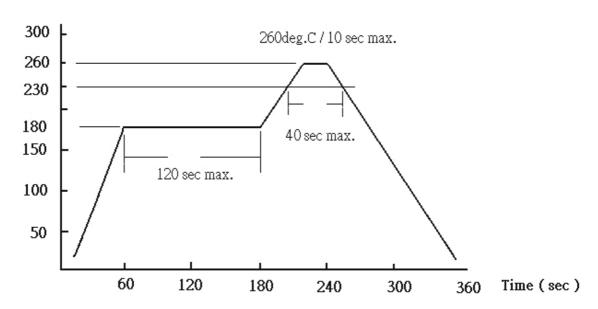


### 13 Frequency VS Temperature



#### 14 Soldering Reflow

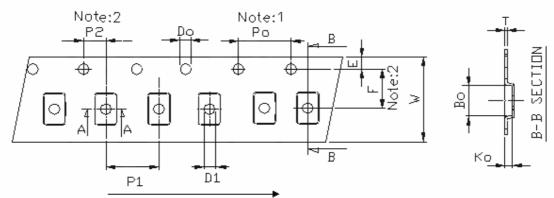
Temp. (deg.C)



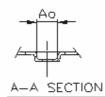
**Reliability Test** (applicable to 49(50) type .U type and Tuning Fork X'tal)

TD and Id a second	m . G . W.	Specification			
Test Items	Test Condition	Dip	SMD		
1. Gross Leak	FC-40 125°C/30sec	No continuous bubble			
Test					
2. Fine Leak	Bombing of He 4kg/cm <sup>2</sup> for 2 hours	Less than 5*10^-8ati	m.c.c./sec, Helium		
Test					
3. Drop Test	a ~19.999MHz(Fund.) →75 cm height	$\triangle F \leq \pm 10 PPM$ ,	△F≦±10PPM,		
	b. $20\sim29.999$ MHz(Fund.) $\rightarrow$ 50 cm height	C.I within spec.	C.I within spec.		
	c. $30\sim$ MHz(Fund.) $\rightarrow$ 20 cm height				
	on hard wooden surface / 3 times				
	( thickness more than 30 mm)				
4. Vibration Test	Freq. range: 10~55Hz	△F≦± 10PPM,	△F≦±10PPM,		
	Peak to peak amplitude: 1.5mm	C.I within spec.	C.I within spec.		
	3 direction(X,Y,Z), each 60min.				
5. Resistance to	a. IR Reflow furnace with the condition 2		△F≦±10PPM,		
Soldering Test	times. Peak temp.260 $\pm 3^{\circ}$ C , 10 $\pm 1$ sec.	NA	C.I within spec.		
			For SMD type only.		
	<ul> <li>b. Dip terminals in a 245±5°C solder station(pool)</li> <li>Dipping depth 0.5mm(Min) Dipping</li> <li>time 5±0.5 sec.</li> </ul>	At least 90% by 30X magnification of each dipped area shall be covered by fresh solder. For DIP type only.	NA		
6. Bending Test	Bending cycle: 1 cycle	△F≦±5PPM,			
	$0^{\circ} -> 45^{\circ} -> 0^{\circ} -> 45^{\circ} -> 0^{\circ}$	C.I within spec.	NA		
		For DIP type only.			
7. Shearing Test	Weight : 5N,		△F≦±10PPM,		
	Test duration: 10±1 sec	NA	C.I within spec.		
			For SMD type only.		
8. Low Temp.	40+2% 240+121	$\triangle F \leq \pm 10 PPM$ ,	△F≦±10PPM,		
Exposure Test	-40±3°€, 240±12 hrs	C.I within spec.	C.I within spec.		
9. Aging Test	85±3°C, 240±12hrs	$\triangle F \leq \pm 10 PPM$ ,	$\triangle F \leq \pm 10 PPM$ ,		
	85±3 (, 240±12fits	C.I within spec.	C.I within spec.		
10. High Temp. &		△F≦± 10PPM,	△F≦±10PPM,		
Humidity Test	105 C±5 C& 05/0±5/0 R.11. , 240±12 III8	C.I within spec.	C.I within spec.		
11. Temperature	-25±3°C/15±3min ~ +85±3°C/15±3min	$\triangle F \leq \pm 10 PPM$ ,	$\triangle F \leq \pm 10 PPM$ ,		
Cycling Test	15cycles	C.I within spec.	C.I within spec.		

#### **Taping**



Tape Running Direction



$$A_0 = 1.90 \pm 0.10$$
 mm  
 $B_0 = 3.60 \pm 0.10$  mm  
 $K_0 = 1.0 \pm 0.10$  mm

#### Unit: mm

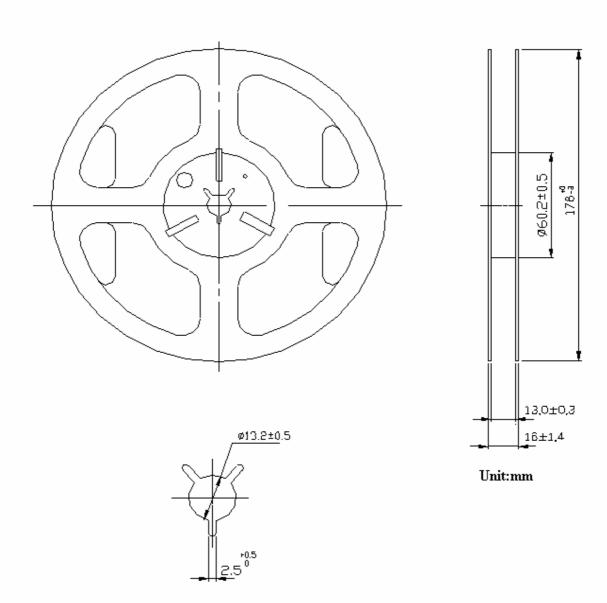
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Symbol	Spec.		
K1	_		
Po	4.0± 0.10		
P1	4.0± 0.10		
P2	2.0± 0.05		
Do	1,50± 0,10		
D1	1.0+0.2		
Е	1.75± 0.10		
F	5.50±0.05		
10Po	40.0±0.10		
W	12,0± 0,2		
Т	0.30± 0.05		

#### Notice:

- 1 10 Sprocket hole pitch cumulative tolerance is  $\pm 0.1 \mathrm{mm}$
- Pocket position relative to sprocket hale measured as true position of packet not packet hale.
- 3. Ao & Bo measured on a place 0.3mm above the bottom of the pocket to top surface of the carrier.
- Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier
- 5. Carrier camber shall be not than 1mm per 100mm through a length of 250mm.

	Date	Name	Unit:mm			
Drawn	18.Jan.2007	Leo	Title		Drawing No.	
Checked	18.Jan.2007	Iris	Tape & Reel Dimension		C009-010310-X-1001	
Approved	18.Jan.2007	Wan				

## Reel



Q'ty:3000pcs/reel

	Date	Name	Unit:mm			
Drawn	18.Jan.2007	Leo	Title		Drawing No.	
Checked	18.Jan.2007	Iris	Tape & Reel Dimension		C009-0713-X-1001	
Approved	18.Jan.2007	Wan				